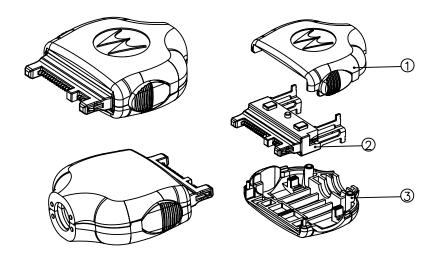
			10012838-001LF	10012838-004LF	10012838-003LF	REMARK
	DESCRIPTION	PART NUMBER	Q'TY	Q'TY	Q ' TY	
1	TOP COVER	10017335-001	1	1	N/A	WITH "M" LOGO
		10017335-002	N/A	N/A	1	WITHOUT "M" LOGO
2	17P DATA PLUG ASS'Y	10028885-001LF	1	1	1	
3	BOTTOM COVER	10017334-001	1	1	1	
	REMARK			Special package		



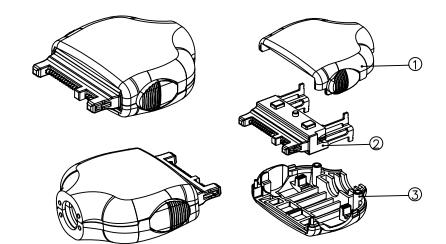
10012838-001LF/001/004LF

Notes:

- 1. The housing of 10028885-xxx will withstand exposure to 260°C peak temperature for 10 seconds in a convection, infra red vapor phase reflow oven
- 2. 10012838-001LF meets European union directives and other country regulations as described in GS-22-008

1 2

- 3. Lead free label on the carton of 10028885-001LF per GS-14-920
- 4. Plating specification for terminal: 1.2 um minimun nickel all over followed by: Contact side: 0.8 um minimun Au Solder tail side: $2.5 \sim 10$ um pure Sn for 10028885-001LF/003LF



10012838-003LF

mat'l. code								tolerances unless otherwise specified							CUSTOMER			CI	ļ						
ltr	tr ecn no dr date					.X ± 0.15						(COPY	,	FC) www.fciconnect.com										
С	T03-	T03-0322 M W 08/06/03			linear .XX ± 0.			0.10	0	proje	ection		title												
D	T04-0217 M W 05/19/04			.xxx ±								17P DATA PLUG ASS'Y													
Ε	DG04-0077 P M 10/12/04			angles .0° ± 2°					Ψ 4																
F	DG04-	OG04-0096 P M 12/16/04		6/04	u			05/2	2/03	1 IVIIVI I		,						code	е						
G	DG05-	-0099	Ρ	М	07/1	1/05	engr LEIF SHEN 05/22/03				2/03	-		-	size dwg no								-		
Н	DG06-0452 C L 11/07/06						PAUL WANG 05/22/03							Α4	44 10012838 shee					et					
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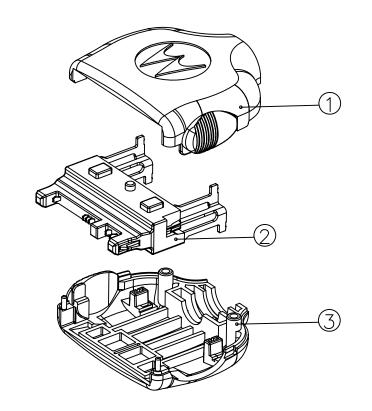
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other country regulations as described in GS-22-008
Lead free label on the carton of 10028885-002LF
per GS-14-920
Plating specification for terminal:
1.2 um minimun nickel all over followed by:
Contact side: 0.8 um minimun Au
Solder tail side: 2.5 ~ 10 um pure Sn for

10028885-002LF

1. The housing of 10028885-xxx will withstand exposure

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mat'l. code						tolerances unless otherwise specified							CUSTOMER			FC)									
Itr	ecn	no	dr	date		.X ± 0.15			5																
С					linea	r	.XX ± 0.10			0	projection		title												
							.XXX ±						17P DATA PLUG ASS'Y												
					angle	angles			.0° ± 2°			। कि दा													
				dr	dr MAGGIE WU			05/22/03				product family MOBILE I/O code								e					
						LEIF					-			size dwg no							-				
						PAL	PAUL WANG 05/22/0			2/03	scale		ا ۸	10012838 sheet						et					
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									7						cage	code					_				

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to 260°C peak temperature for 10 seconds in a convection, infra red vapor phase reflow oven 2. 10012838-002LF meets European union directives and

Notes:

3.

4.

